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4 August 1964

MEMORANDUM	FOR	بالبابال	DEGUDD
	エフスロ	TOP.	RHANDERIN

SUBJECT: Interface Problems -- Chip Printer and Chip Processor

l. The contract for a Specific Format Chip Printer is to result in the design, fabrication and delivery of an operational chip printer. The work "operational" is stressed here as it is felt that sufficient knowledge and experience has been gained in the past through other chip systems to enable bypassing the breadboard or prototype phase in the development cycle of a chip printer. Concurrently, a contract to develop a prototype chip processor is being carried out.	25X1A 25X1A 25X1A		
2. The printer, presently in the Preliminary Design phase, is intended to produce high-resolution cut film chips of selected areas for interpretation and mensuration. The proposed design will simply place the exposed film into a hopper for subsequent transfer to the processor. The processor design requires the film chips to be contained in a mount for transport through the chemical, wash, and drier.			
3. A meeting has been set-up representatives to discuss methods of nandling the chip in the printer for subsequent transfer to the processor. It is anticipated this will result in a proposal from one or both companies for a handling mechanism to load the film chips into the mounts required by the processor. Ideally, a vertical magazine containing x number of empty mounts on an elevator mechanism in the printer actuated so that each chip, as it is printed, is placed in a mount, then the magazine, when full, or when desired, can be lifted out of the printer and placed in a similar receptacle on the processor. At present the mount design is unknown. However, it is anticipated the representative will have sufficient 25X1A methods.			
4. The meeting is presently scheduled for 12 August 1964	25X1 7 25X1		
	25X1A		
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